Welcome to [E-XFL.COM](#)**Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)**

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

**Applications of Embedded - CPLDs****Details**

Product Status	Obsolete
Programmable Type	In System Programmable
Delay Time tpd(1) Max	10 ns
Voltage Supply - Internal	4.5V ~ 5.5V
Number of Logic Elements/Blocks	-
Number of Macrocells	256
Number of Gates	-
Number of I/O	160
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	208-BFQFP
Supplier Device Package	208-PQFP (28x28)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/lattice-semiconductor/m5-256-160-10yi-1">https://www.e-xfl.com/product-detail/lattice-semiconductor/m5-256-160-10yi-1</a>

Table 2. MACH 5 Speed Grades

Device	Speed Grade <sup>1</sup>						
	-5	-6	-7	-10	-12	-15	-20
M5-128 <sup>2</sup>			C	C, I	C, I	C, I	I
M5-128/1	C		C, I	C, I	C, I	C, I	I
M5LV-128	C		C,I	C, I	C, I	I	
M5-192/1	C		C, I	C, I	C, I	C, I	I
M5-256 <sup>2</sup>			C	C, I	C, I	C, I	I
M5-256/1	C		C, I	C, I	C, I	C, I	I
M5LV-256	C		C, I	C, I	C, I	I	
M5-320		C	C, I	C, I	C, I	C, I	I
M5LV-320		C	C, I	C, I	C, I	C, I	I
M5-384		C	C, I	C, I	C, I	C, I	I
M5LV-384		C	C, I	C, I	C, I	C, I	I
M5-512		C	C, I	C, I	C, I	C, I	I
M5LV-512		C	C, I	C, I	C, I	C, I	I

**Note:**

1. C = Commercial grade, I = Industrial grade
2. /1 version recommended for new designs

With Lattice's unique hierarchical architecture, the MACH 5 family provides densities up to 512 macrocells to support full system logic integration. Extensive routing resources ensure pinout retention as well as high utilization. It is ideal for PAL® block device integration and a wide range of other applications including high-speed computing, low-power applications, communications, and embedded control. At each macrocell density point, Lattice offers several I/O and package options to meet a wide range of design needs (Table 3).

Table 3. MACH 5 Package and I/O Options<sup>1</sup>

Supply Voltage	M5-128/1 M5LV-128		M5-256/1 M5LV-256		M5-320 M5LV-320		M5-384 M5LV-384		M5-512 M5LV-512		
	5	3.3	5	5	3.3	5	3.3	5	3.3	5	3.3
100-pin TQFP	68	68, 74	68	68	68*, 74						
100-pin PQFP	68	68*	68*	68*	68						
144-pin TQFP		104			104						
144-pin PQFP	104	104*	104*	104*	104*						
160-pin PQFP	120	120	120	120	120	120*	120	120*	120	120*	120
208-pin PQFP				160	160	160	160	160	160	160	160
240-pin PQFP						184*	184*	184*	184*	184*	184*
256-ball BGA						192	192*	192*	192*	192*	192*
352-ball BGA										256	256

**Note:**

1. The I/O options indicated with a "\*" are obsolete, please contact factory for more information.

Advanced power management options allow designers to incrementally reduce power while maintaining the level of performance needed for today's complex designs. I/O safety features allow for mixed-voltage design,

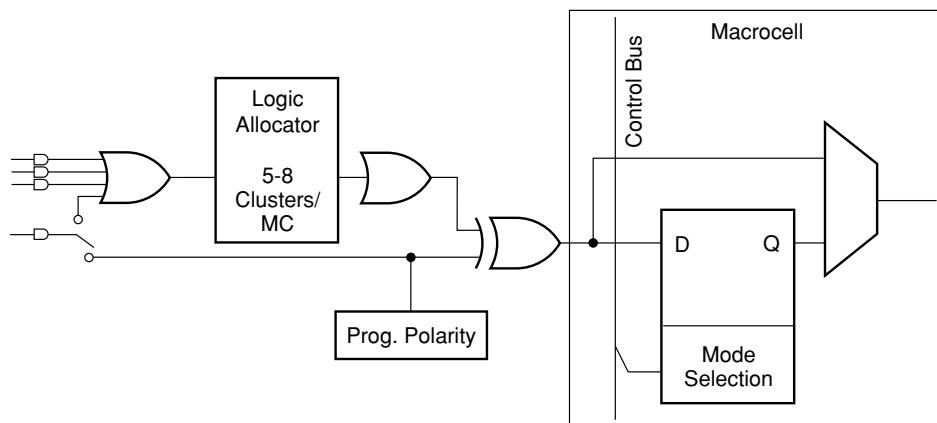
Select devices have been discontinued.  
See Ordering Information section for product status.

## Macrocells

The macrocells for MACH 5 devices consist of a storage element which can be configured for combinatorial, registered or latched operation (Figure 3). The D-type flip-flops can be configured as T-type, J-K, or S-R operation through the use of the XOR gate associated with each macrocell.

Each PAL block has the capability to provide two input registers by using macrocells 0 and 15. In order to use this option, these macrocells must be accessed via the I/O pins associated with macrocells 3 and 12, respectively. Once the macrocell is used as an input register, it cannot be used for logic, so its clusters can be re-directed through the logic allocator to another macrocell. The

I/O pins associated with macrocells 0 and 15 can still be used as input pins. Although the I/O pins for macrocells 3 and 12 are used to connect to the input registers, these macrocells can still be used as “buried” macrocells to drive device logic via the matrix.



20446G-003

**Figure 3. Macrocell Diagram**

## Control Generator

The control generator provides four configurable clock lines and three configurable set/reset lines to each macrocell in a PAL block. Any of the four clock lines and any of the three set/reset lines can be independently selected by any flip-flop within a block. The clock lines can be configured to provide synchronous global (pin) clocks and asynchronous product term clocks, sum term clocks, and latch enables (Figure 4). Three of the four global clocks, as well as two product-term clocks and one sum-term clock, are available per PAL block. Positive or negative edge clocking is available as well as advanced clocking features such as **complementary** and **biphase** clocking. Complementary clocking provides two clock lines exactly 180 degrees out of phase, and is useful in applications such as fast data paths. A biphase clock line clocks flip-flops on both the positive and negative edges of the clock. The configuration options for the four clock lines per PAL block are as follows:

### Clock Line 0 Options

- ◆ Global clock (0, 1, 2, or 3) with positive or negative edge clock enable
- ◆ Product-term clock ( $A^*B^*C$ )
- ◆ Sum-term clock ( $A+B+C$ )

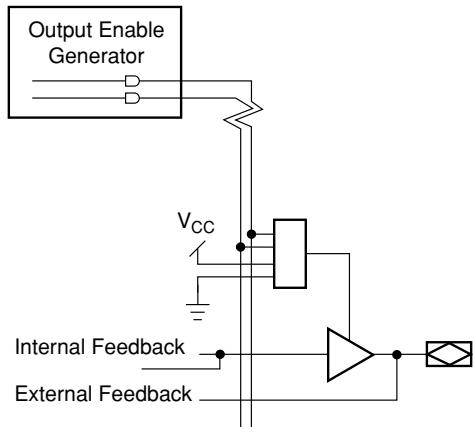
### Clock Line 1 Options

- ◆ Global clock (0, 1, 2, or 3) with positive edge clock enable
- ◆ Global clock (0, 1, 2, or 3) with negative edge clock enable

Select devices have been discontinued.  
See Ordering Information section for product status.

## OE Generator

There is one output enable (OE) generator per PAL block that generates two product-term driven output enables. Each I/O cell is simply an output buffer. Each I/O cell within the PAL block can choose to be permanently enabled, permanently disabled, or choose one of the two product term output enables per PAL block (Figure 6).



20446G-006

Figure 6. Output Enable Generator and I/O Cell

**See Ordering Information section for product status.**

Select devices have been discontinued.

## MULTIPLE I/O AND DENSITY OPTIONS

The MACH 5 family offers six macrocell densities in a number of I/O options. This allows designers to choose a device close to their logic density and I/O requirements, thus minimizing costs. For the same package type, every density has the same pin-out. With proper design considerations, a design can be moved to a higher or lower density part as required.

## IEEE 1149.1 - COMPLIANT BOUNDARY SCAN TESTABILITY

Most MACH 5 devices have boundary scan registers and are compliant to the IEEE 1149.1 standard. This allows functional testing of the circuit board on which the device is mounted through a serial scan path that can access all critical logic nodes. Internal registers are linked internally, allowing test data to be shifted in and loaded directly onto test nodes, or test node data to be captured and shifted out for verification. In addition, these devices can be linked into a board-level serial scan path for more complete board-level testing.

## IEEE 1149.1 - COMPLIANT IN-SYSTEM PROGRAMMING

Programming devices in-system provides a number of significant benefits including: rapid prototyping, lower inventory levels, higher quality, and the ability to make in-field modifications. All MACH 5 devices provide in-system programming (ISP) capability through their IEEE 1149.1-compliant Boundary Scan Test Access Port. By using the IEEE 1149.1-compliant Boundary Scan Test Access Port as the communication interface through which ISP is achieved, customers get the benefit of a standard, well-defined interface.

MACH 5 devices can be programmed across the commercial temperature and voltage range. The PC-based LatticePRO software facilitates in-system programming of MACH 5 devices. LatticePRO software takes the JEDEC file output produced by design implementation software, along with information about the Boundary Scan chain, and creates a set of vectors that are used to drive the Boundary Scan chain. LatticePRO software can use these vectors to drive a Boundary Scan chain via the parallel port of a PC. Alternatively, LatticePRO software can output files in formats understood by common automated test equipment. This equipment can then be used to program MACH 5 devices during the testing of a circuit board.

## PCI COMPLIANT

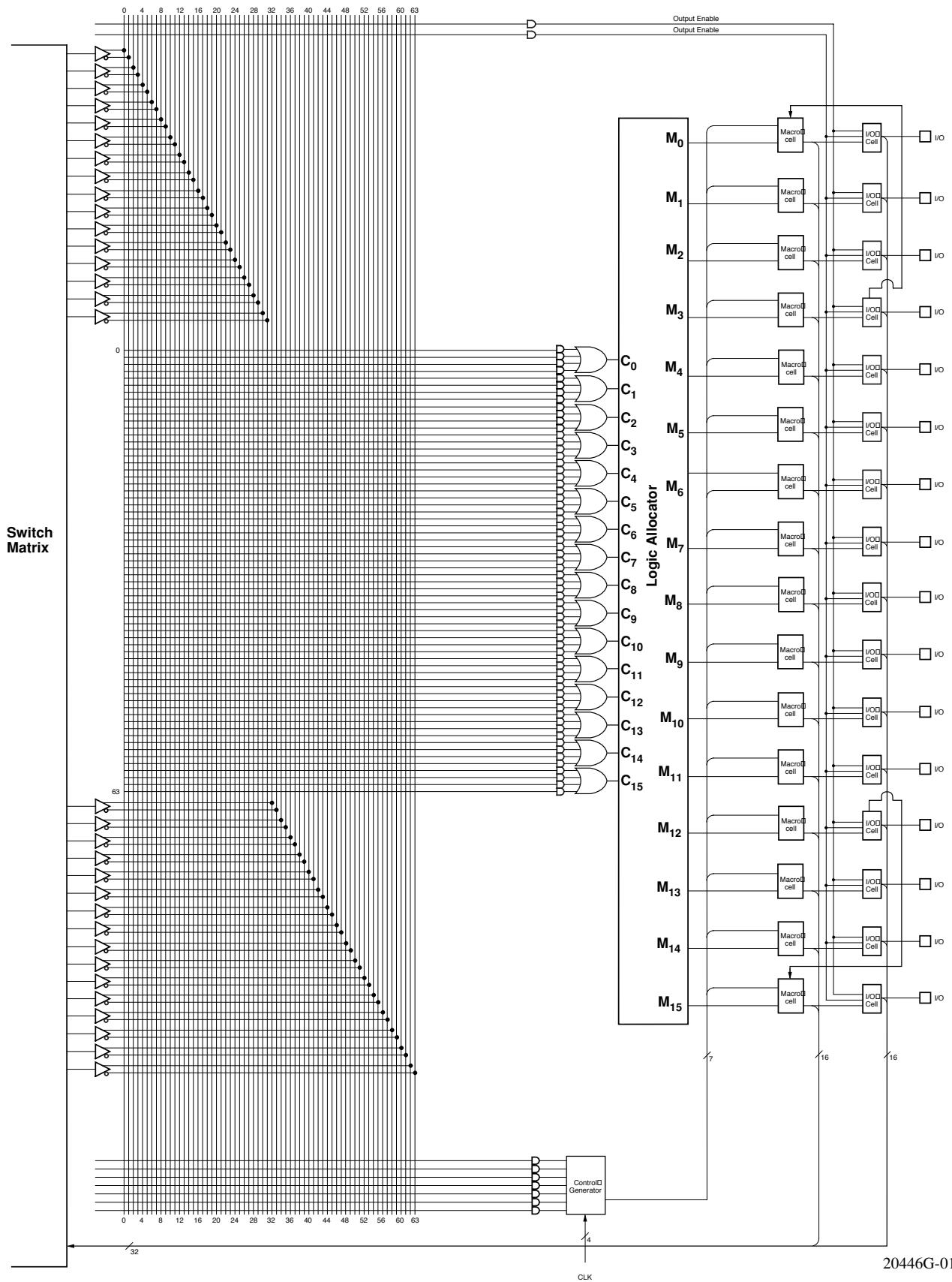
MACH 5 devices in the -5/-6/-7/-10/-12 speed grades are compliant with the *PCI Local Bus Specification* version 2.1, published by the PCI Special Interest Group (SIG). The 5-V devices are fully PCI-compliant. The 3.3-V devices are mostly compliant but do not meet the PCI condition to clamp the inputs as they rise above  $V_{CC}$  because of their 5-V input tolerant feature. MACH 5 devices provide the speed, drive, density, output enables and I/Os for the most complex PCI designs.

**Select devices have been discontinued.  
See Ordering Information section for product status.**

## **SECURITY BIT**

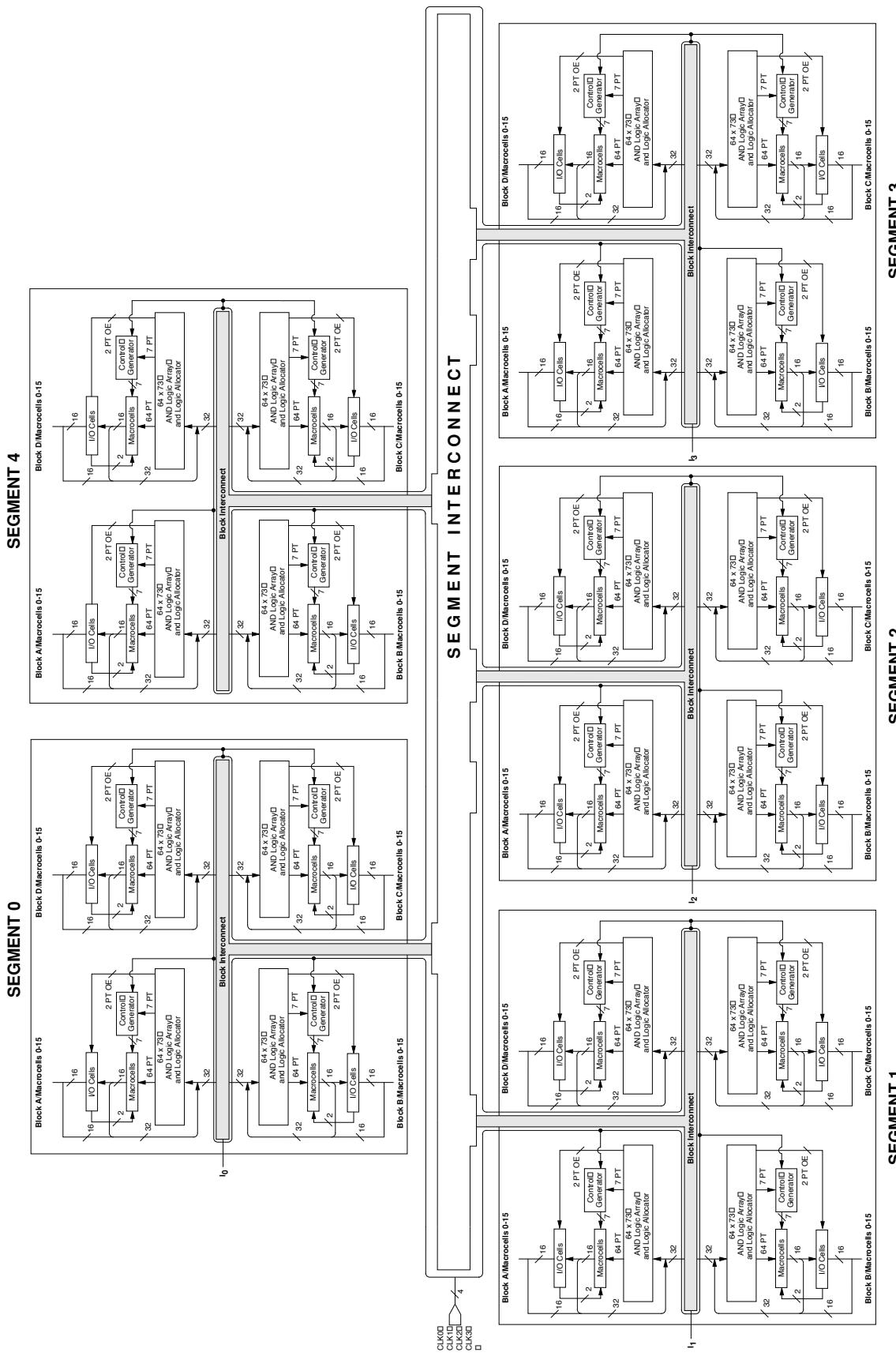
A programmable security bit is provided on the MACH 5 devices as a deterrent to unauthorized copying of the array configuration patterns. Once programmed, this bit defeats readback of the programmed pattern by a device programmer, securing proprietary designs from competitors. Programming and verification are also defeated by the security bit. The bit can only be reset by erasing the entire device.

## MACH 5 PAL BLOCK



Select devices have been discontinued.  
See Ordering Information section for product status.

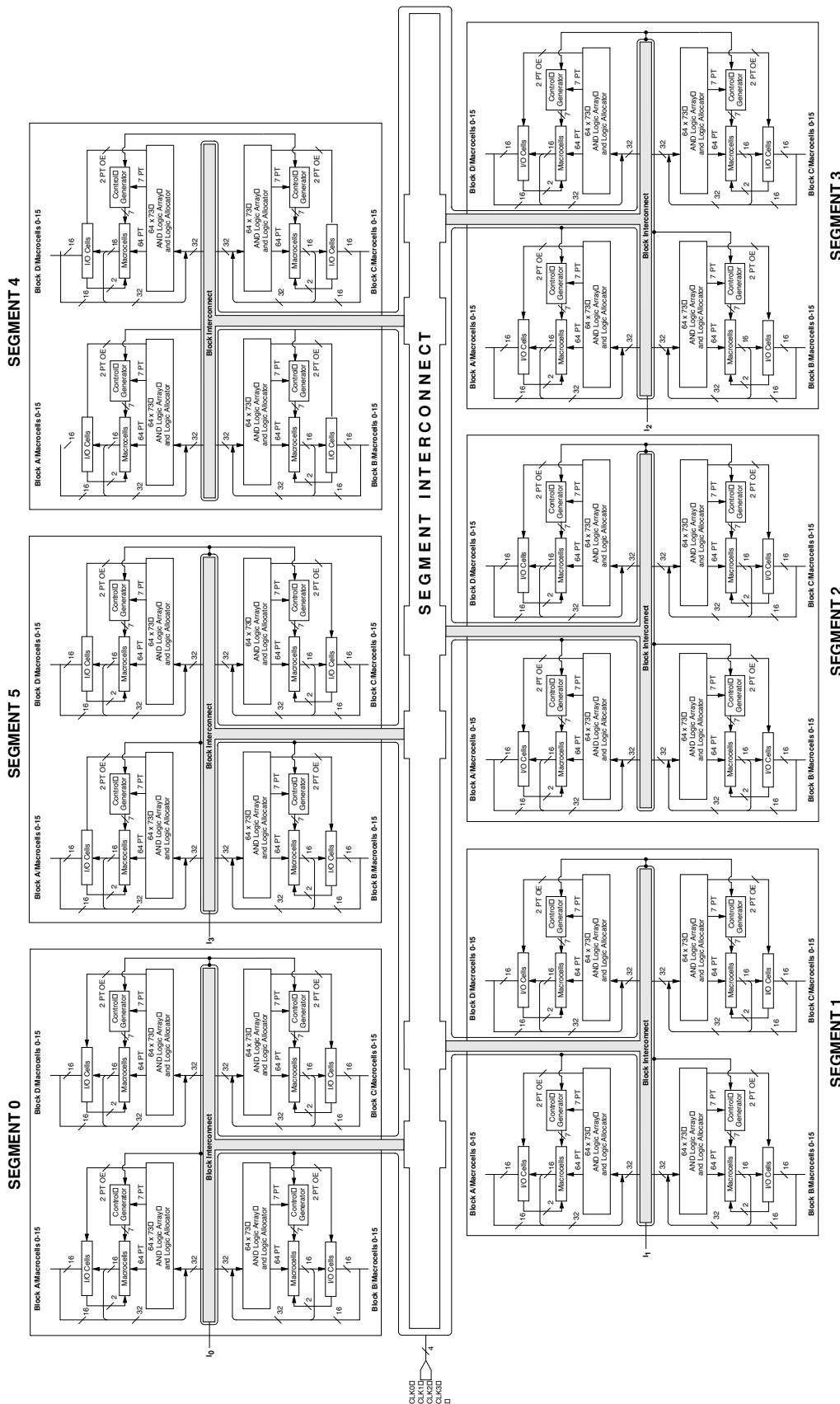
## BLOCK DIAGRAM — M5(LV)-320/XXX



Select devices have been discontinued.  
See Ordering Information section for product status.

**Select devices have been discontinued.**  
**See Ordering Information section for product status.**

## BLOCK DIAGRAM — M5(LV)-384/XXX



20446G-011

**Select devices have been discontinued.  
See Ordering Information section for product status.**

## M5(LV) TIMING PARAMETERS OVER OPERATING RANGES<sup>1</sup> (CONTINUED)

	-5		-6		-7		-10		-12		-15		-20		Unit	
	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max		
<b>Power Delays:</b>																
t <sub>PL1</sub>	Power level 1 delay (Note 2)		4.0 (5.0)		4.0		4.0 (5.0)		4.0 (5.0)		4.0 (5.0)		4.0 (5.0)		4.0 (5.0)	ns
t <sub>PL2</sub>	Power level 2 delay (Note 2)		6.0 (9.0)		6.0		6.0 (9.0)		6.0 (9.0)		6.0 (9.0)		6.0 (9.0)		6.0 (9.0)	ns
t <sub>PL3</sub>	Power level 3 delay (Note 2)		9.0 (17.5)		9.0		9.0 (17.5)		9.0 (17.5)		9.0 (17.5)		9.0 (17.5)		9.0 (17.5)	ns
<b>Additional Cluster Delay:</b>																
t <sub>PT</sub>	Product term cluster delay		0.3		0.3		0.3		0.3		0.3		0.3		0.3	ns
<b>Interconnect Delays:</b>																
t <sub>BLK</sub>	Block interconnect delay		1.5		1.5		1.5		2.0		2.0		2.0		2.0	ns
t <sub>SEG</sub>	Segment interconnect delay		4.5		4.5		5.0		6.0		6.0		6.0		6.0	ns
<b>Reset and Preset Delays:</b>																
t <sub>SRI</sub>	Asynchronous reset or preset to internal register output		6.0		8.0		8.0		10.0		12.0		14.0		16.0	ns
t <sub>SR</sub>	Asynchronous reset or preset to register output		8.0		10.0		10.0		12.0		14.0		16.0		18.0	ns
t <sub>SRR</sub>	Reset and set register recovery time	5.5		7.5		7.5		8.0		9.0		10.0		11.0		ns
t <sub>SRW</sub>	Asynchronous reset or preset width	3.0		4.0		4.0		5.0		6.0		7.0		8.0		ns
<b>Clock Enable Delays:</b>																
t <sub>CES</sub>	Clock enable setup time	4.0		5.0		5.0		6.0		7.0		7.0		8.0		ns
t <sub>CEH</sub>	Clock enable hold time	3.0		4.0		4.0		5.0		6.0		6.0		7.0		ns
<b>Width:</b>																
t <sub>WLS</sub>	Global clock width low (Note 3)	2.5		3.0		3.0		4.0		5.0		6.0		6.0		ns
t <sub>WHS</sub>	Global clock width high (Note 3)	2.5		3.0		3.0		4.0		5.0		6.0		6.0		ns
t <sub>WLA</sub>	Product term clock width low	3.0		4.0		4.0		5.0		6.0		7.0		8.0		ns
t <sub>WHA</sub>	Product term clock width high	3.0		4.0		4.0		5.0		6.0		7.0		8.0		ns
t <sub>GWA</sub>	Gate width low (for low transparent) or high (for high transparent)	3.0		4.0		4.0		5.0		6.0		7.0		8.0		ns
t <sub>WIR</sub>	Input register clock width low or high	3.0		4.0		4.0		5.0		6.0		7.0		8.0		ns

Select devices have been discontinued.  
See Ordering Information section for product status.

## CAPACITANCE<sup>1</sup>

Parameter Symbol	Parameter Description	Test conditions		Typ	Unit
$C_{IN}$	I/CLK pin	$V_{IN} = 2.0\text{ V}$	$3.3\text{ V or }5\text{ V}, 25^\circ\text{ C}, 1\text{ MHz}$	12	pF
$C_{I/O}$	I/O pin	$V_{OUT} = 2.0\text{ V}$	$3.3\text{ V or }5\text{ V}, 25^\circ\text{ C}, 1\text{ MHz}$	10	pF

1. These parameters are not 100% tested, but are calculated at initial characterization and at any time the design is modified where these parameters may be affected.

## $I_{CC}$ vs. FREQUENCY

These curves represent the typical power consumption for a particular device at system frequency. The selected “typical” pattern is a 16-bit up-down counter. This pattern fills the device and exercises every macrocell. Maximum frequency shown uses internal feedback and a D-type register. Power/Speed are optimized to obtain the highest counter frequency and the lowest power. The highest frequency (LSBs) is placed in common PAL blocks, which are set to high power. The lowest frequency signals (MSBs) are placed in a common PAL block and set to lowest power. For a more detailed discussion about MACH 5 power consumption, refer to the application note entitled *MACH 5 Power* in the Application Notes section on the Lattice Data Book CD-ROM or Lattice web site.

## $I_{CC}$ CURVES AT HIGH /LOW POWER MODES

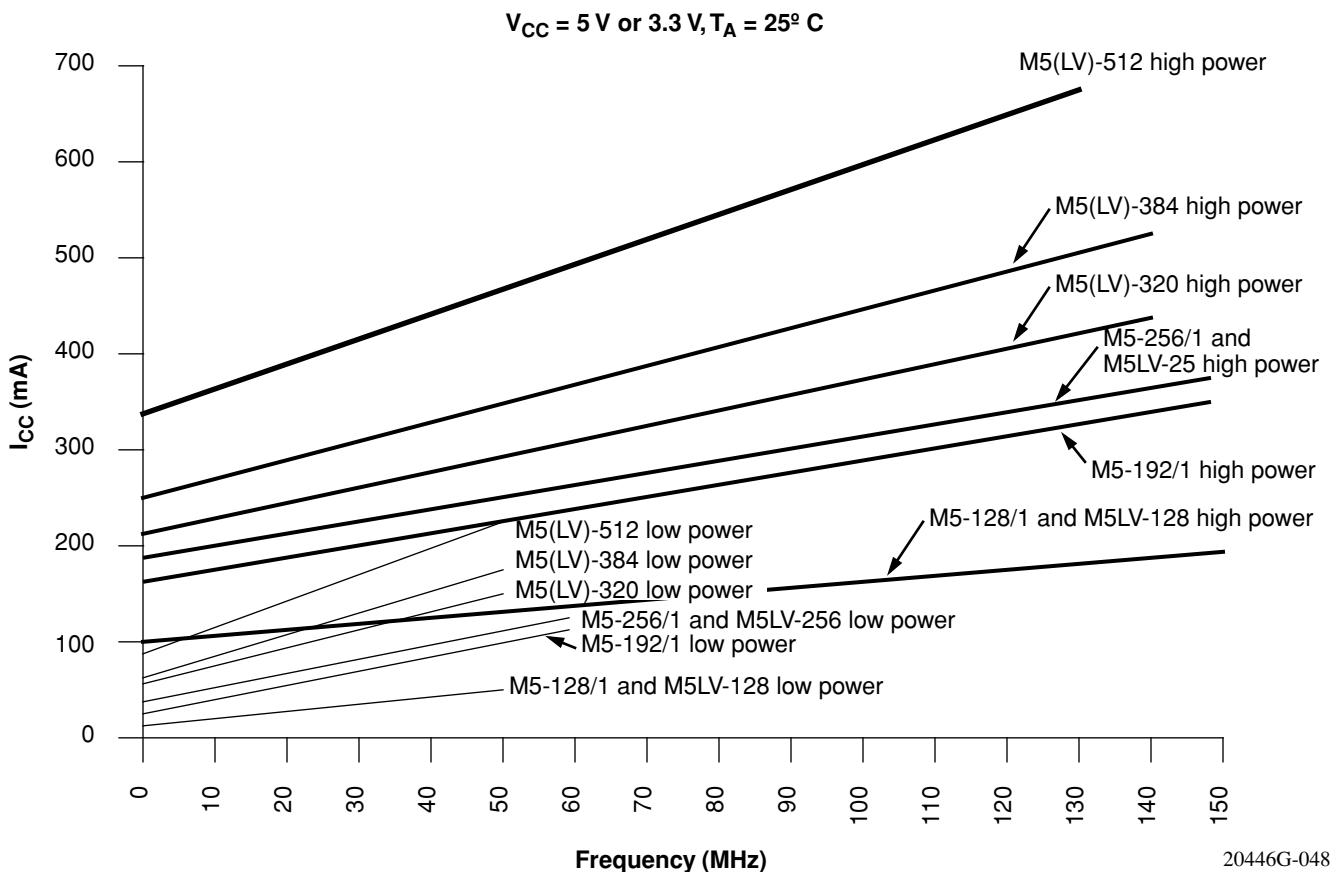
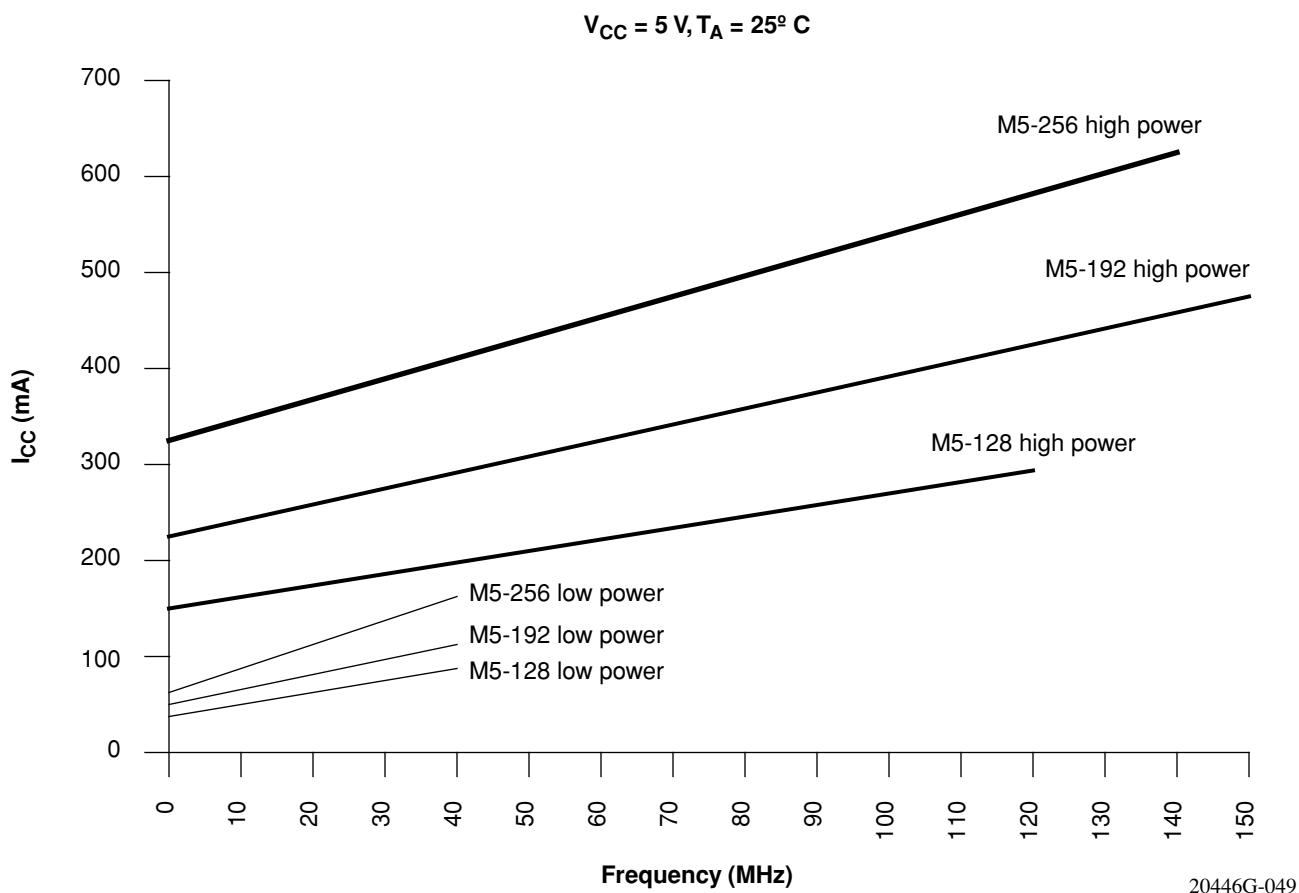


Figure 8.  $I_{CC}$  Curves at High/Low Power Modes

20446G-048



**Figure 9.  $I_{CC}$  Curves at High/Low Power Modes**

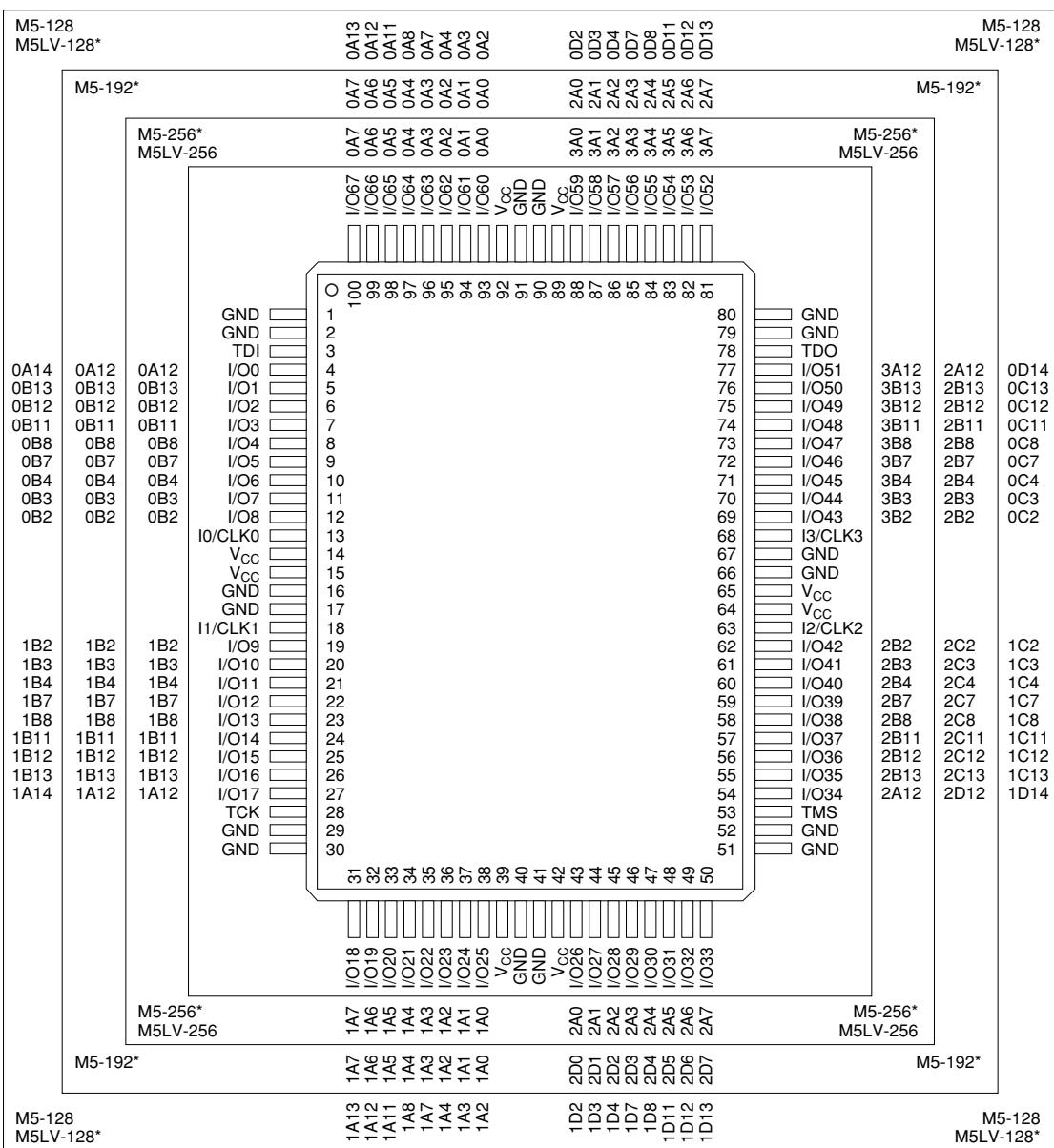
Select devices have been discontinued.  
See Ordering Information section for product status.

**Select devices have been discontinued.**  
**See Ordering Information section for product status.**

## 100-PIN PQFP CONNECTION DIAGRAM

### Top View

100-Pin PQFP (68 I/O)

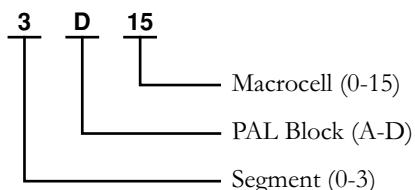


\*Package obsolete, contact factory.

20446G-016

### Pin Designations

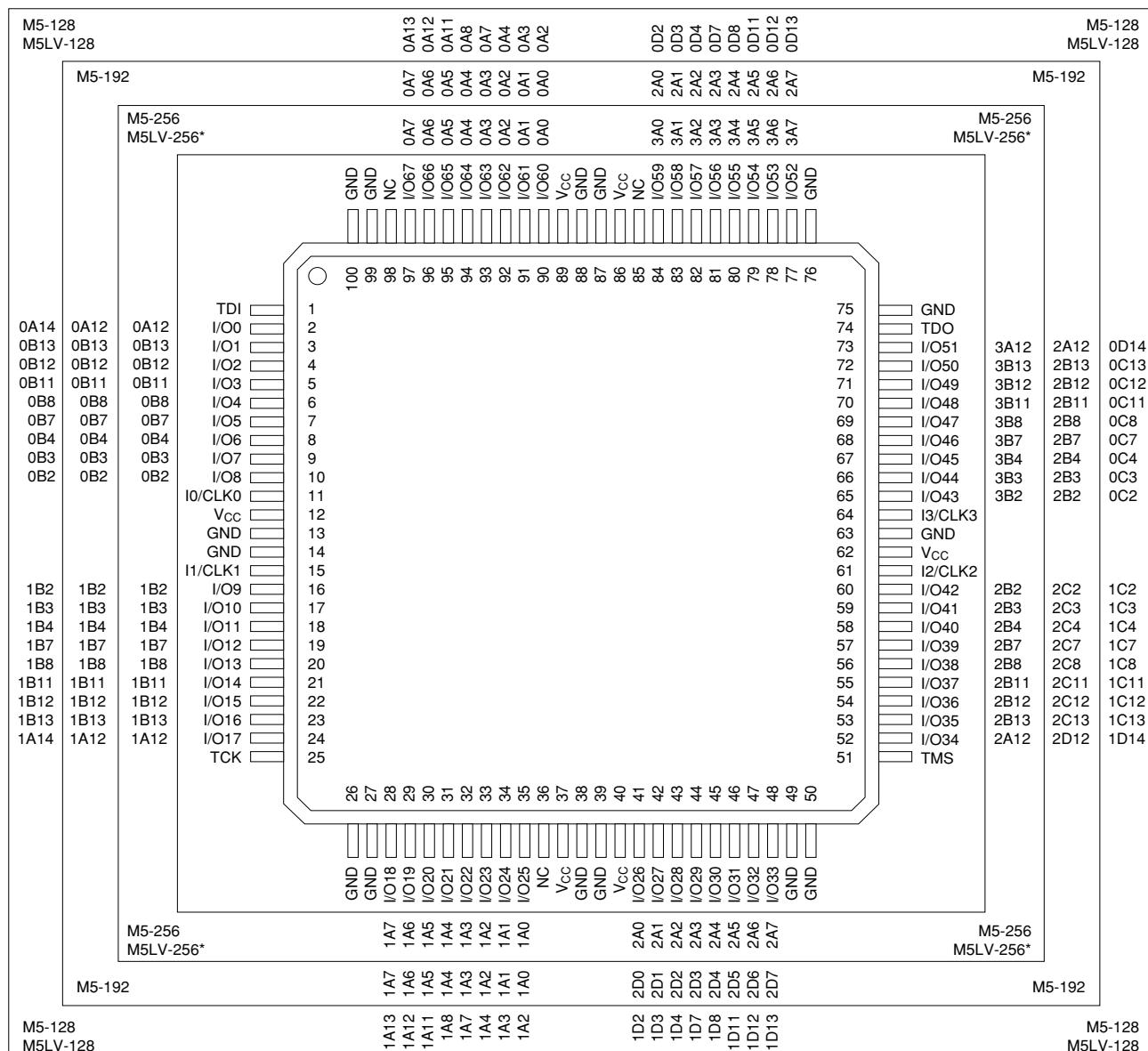
CLK	= Clock	V <sub>CC</sub>	= Supply Voltage
GND	= Ground	TDI	= Test Data In
I	= Input	TCK	= Test Clock
I/O	= Input/Output	TMS	= Test Mode Select
NC	= No Connect	TDO	= Test Data Out



## 100-PIN TQFP CONNECTION DIAGRAM – 68 I/O

### Top View

100-Pin TQFP (68 I/O)



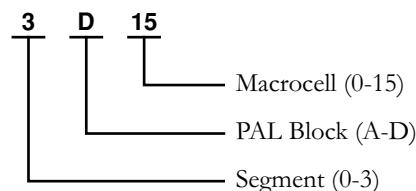
\*Package obsolete, contact factory.

20446G-017

Select devices have been discontinued.  
See Ordering Information section for product status.

### Pin Designations

CLK	= Clock	V <sub>CC</sub>	= Supply Voltage
GND	= Ground	TDI	= Test Data In
I	= Input	TCK	= Test Clock
I/O	= Input/Output	TMS	= Test Mode Select
NC	= No Connect	TDO	= Test Data Out

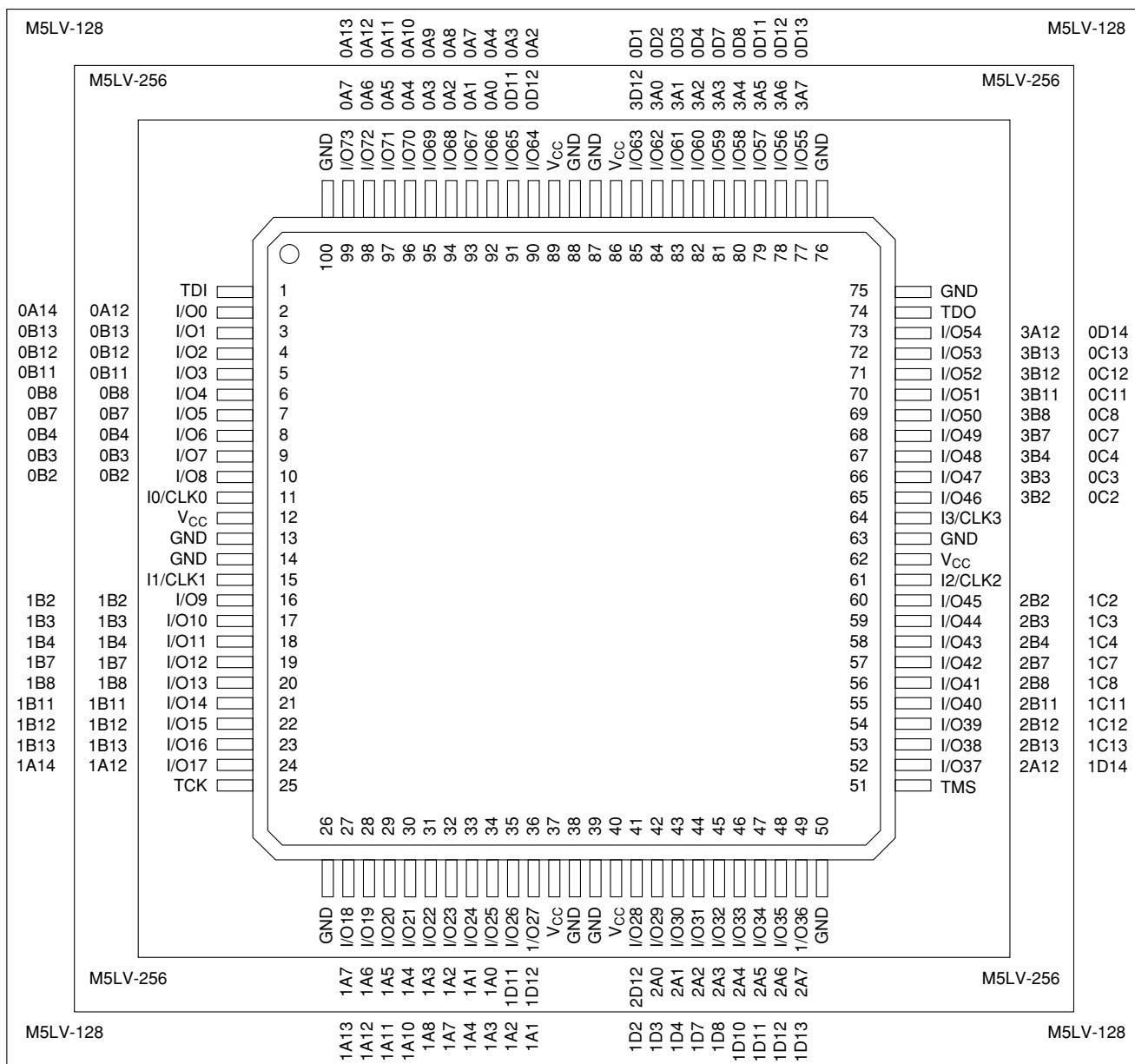


**Select devices have been discontinued.**  
**See Ordering Information section for product status.**

## 100-PIN TQFP CONNECTION DIAGRAM – 74 I/O

### Top View

100-Pin TQFP (74 I/O)

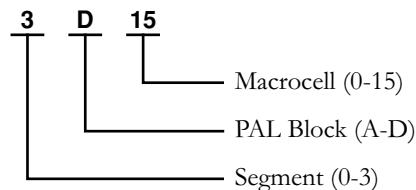


20446G-018

### Pin Designations

CLK	= Clock
GND	= Ground
I	= Input
I/O	= Input/Output
NC	= No Connect

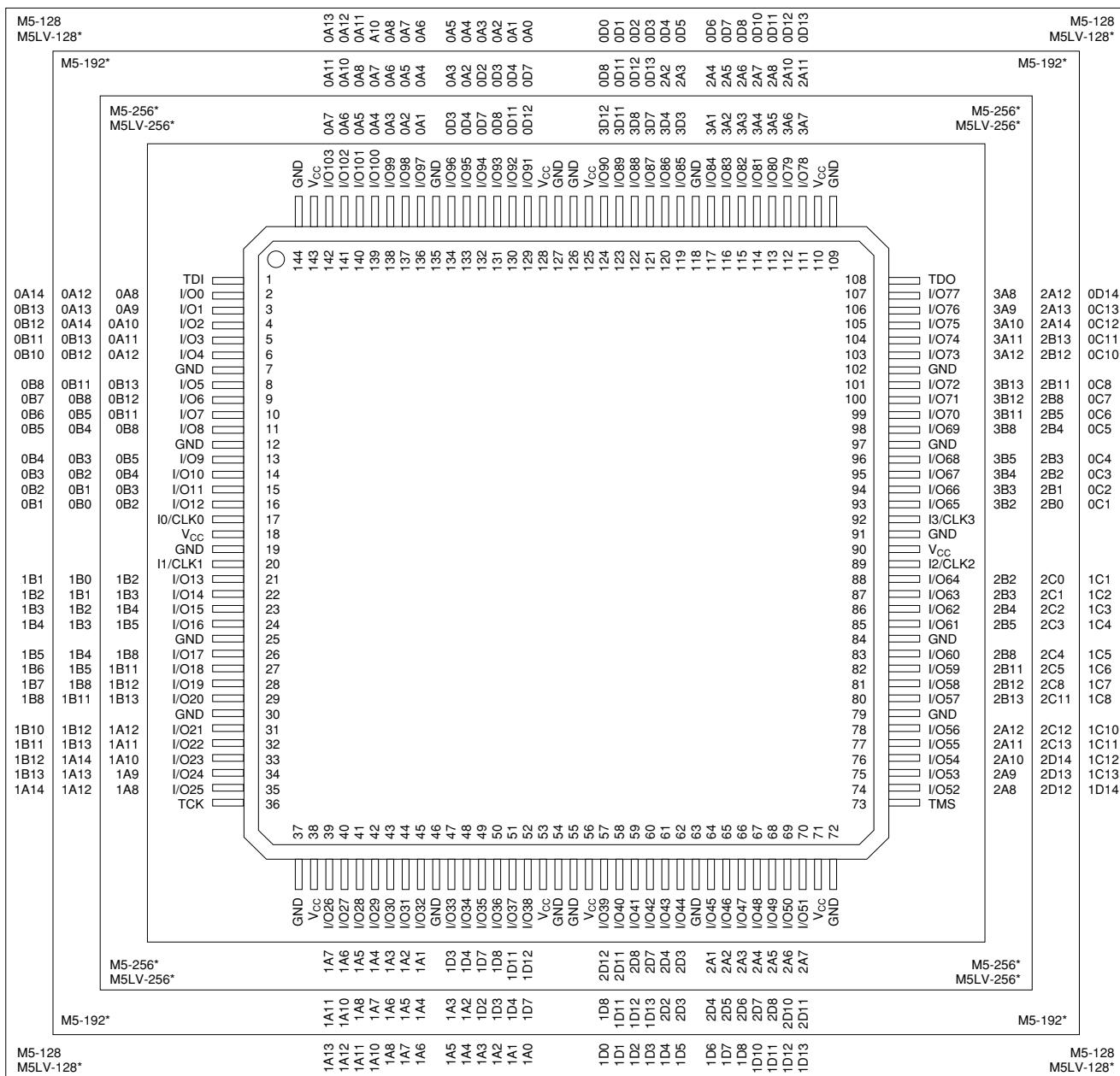
V <sub>CC</sub>	= Supply Voltage
TDI	= Test Data In
TCK	= Test Clock
TMS	= Test Mode Select
TDO	= Test Data Out



## 144-PIN PQFP CONNECTION DIAGRAM

Top View

144-Pin PQFP



\*Package obsolete, contact factory.

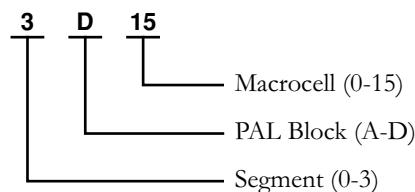
20446G-019

**Select devices have been discontinued.  
See Ordering Information section for product status.**

### Pin Designations

CLK	= Clock
GND	= Ground
I	= Input
I/O	= Input/Output
NC	= No Connect

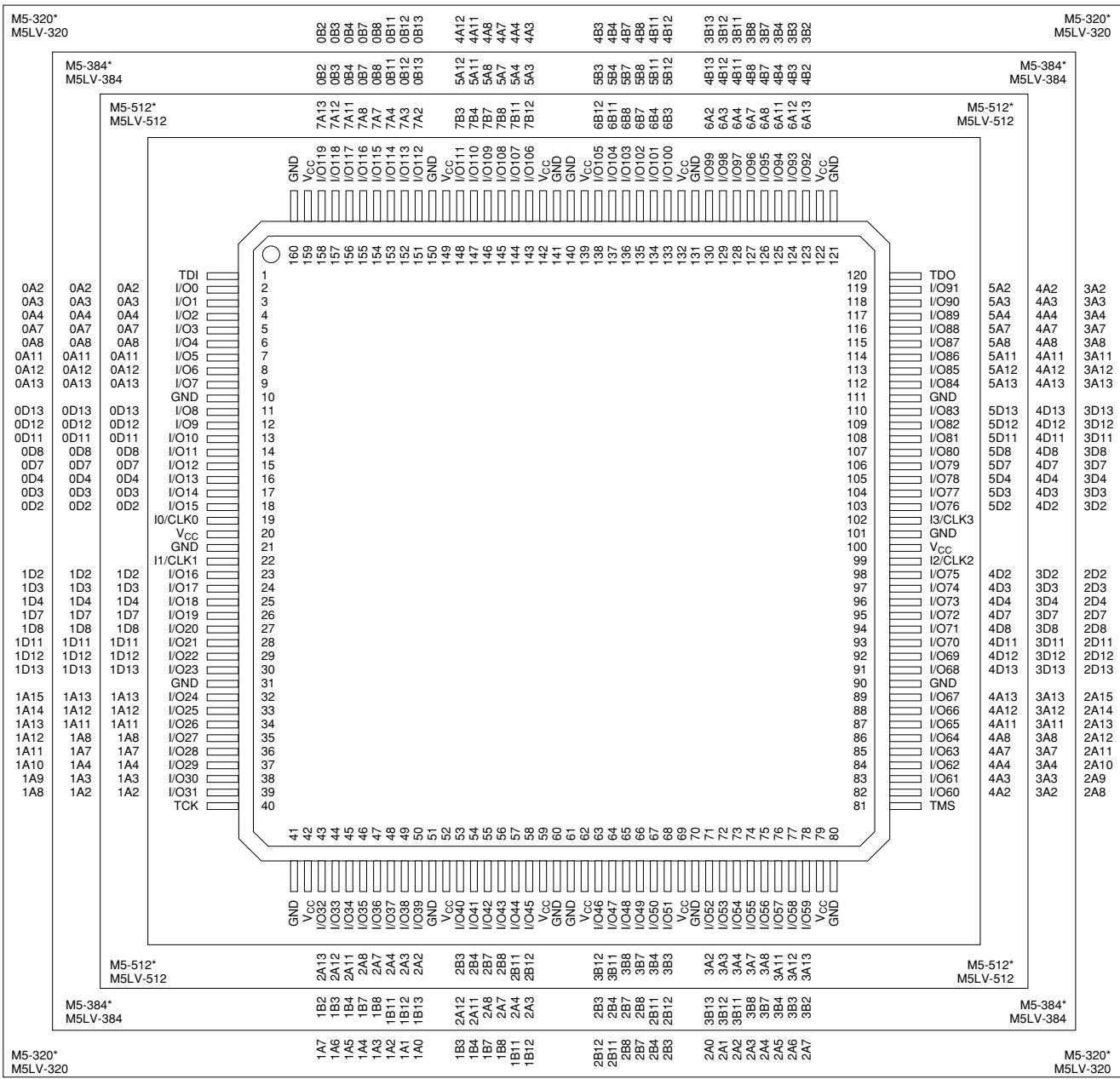
V <sub>CC</sub>	= Supply Voltage
TDI	= Test Data In
TCK	= Test Clock
TMS	= Test Mode Select
TDO	= Test Data Out



**Select devices have been discontinued.**  
**See Ordering Information section for product status.**

## 160-PIN PQFP (WITH INTERNAL HEAT SPREADER) CONNECTION DIAGRAM Top View

160-Pin PQFP (320, 384, 512 Macrocells)

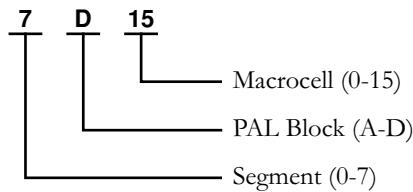


\*Package obsolete, contact factory.

20446G-022

### Pin Designations

CLK	= Clock	V <sub>CC</sub>	= Supply Voltage
GND	= Ground	TDI	= Test Data In
I	= Input	TCK	= Test Clock
I/O	= Input/Output	TMS	= Test Mode Select
NC	= No Connect	TDO	= Test Data Out

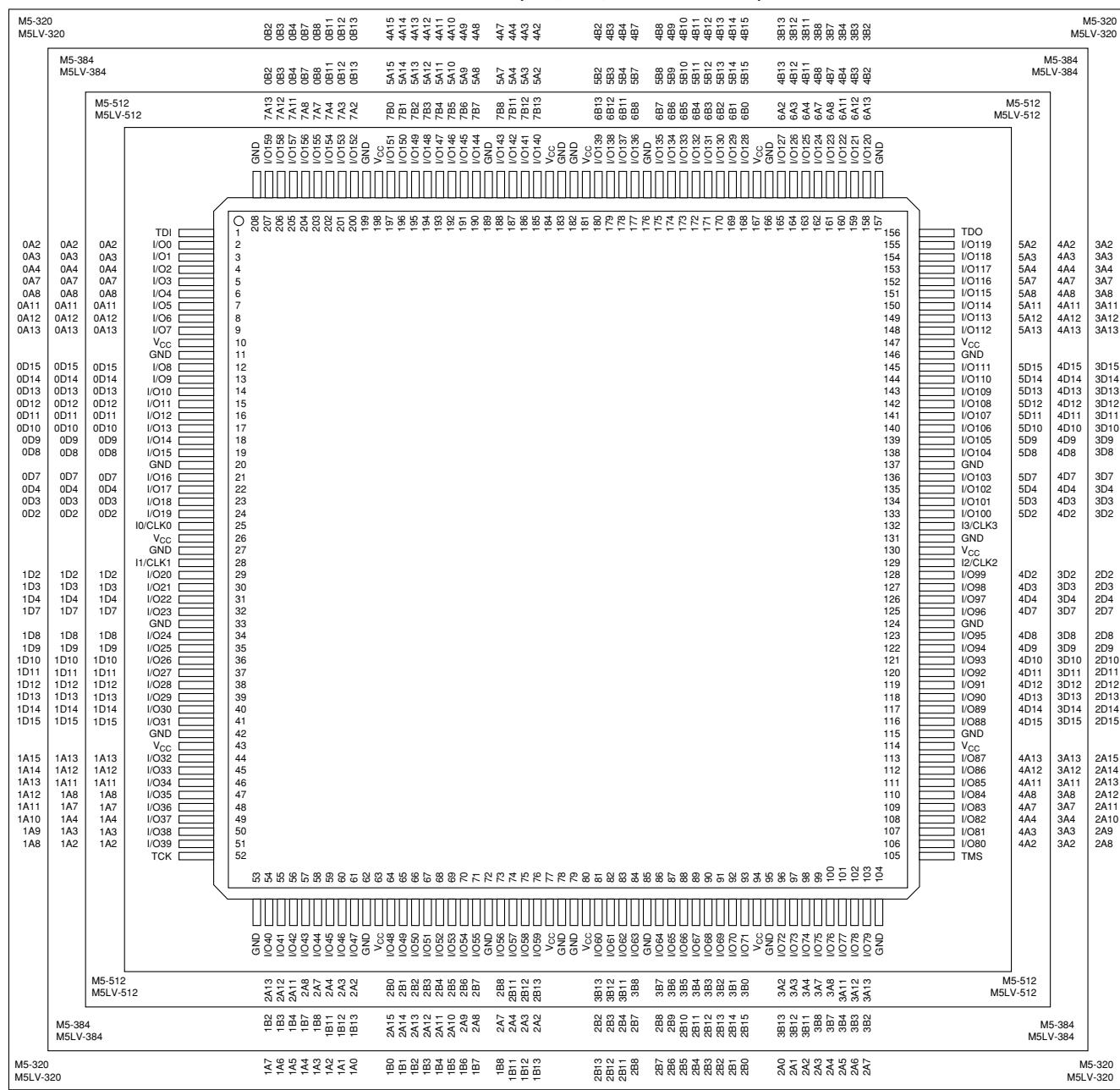


**See Ordering Information section for product status.**

# 208-PIN PQFP (WITH INTERNAL HEAT SPREADER) CONNECTION DIAGRAM

## Top View

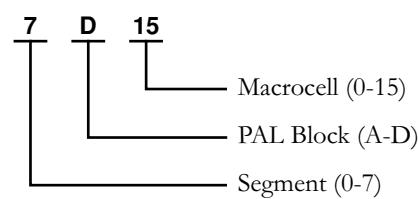
208-Pin PQFP (320, 384, 512 Macrocells)



20446G-024

## Pin Designations

CLK	= Clock	V <sub>CC</sub>	= Supply Voltage
GND	= Ground	TDI	= Test Data In
I	= Input	TCK	= Test Clock
I/O	= Input/Output	TMS	= Test Mode Select
NC	= No Connect	TDO	= Test Data Out



## 256-BALL BGA CONNECTION DIAGRAM — M5-320

Bottom View (I/O Pin-outs)

256-Ball BGA

	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1		
A	GND	I/O11	GND	I/O44	I/O58	GND	I/O70	I/O76	GND	GND	I/O108	I/O116	GND	I/O128	I/O134	GND	GND	GND	A			
B	GND	I/O12	I/O28	I/O45	I/O59	I/O64	I/O71	I/O77	I/O84	I/O90	I/O96	I/O102	I/O117	I/O122	I/O129	I/O135	I/O148	I/O164	GND	B		
C	I/O0	I/O13	V <sub>CC</sub>	I/O46	I/O60	I/O65	I/O72	I/O78	I/O85	I/O91	I/O97	I/O103	I/O110	I/O118	I/O123	I/O130	I/O136	V <sub>CC</sub>	I/O165	I/O181	C	
D	I/O1	I/O14	I/O29	V <sub>CC</sub>	V <sub>CC</sub>	I/O66	V <sub>CC</sub>	I/O79	I/O86	I/O92	I/O98	I/O104	I/O111	V <sub>CC</sub>	I/O124	V <sub>CC</sub>	V <sub>CC</sub>	I/O149	I/O166	I/O182	D	
E	I/O2	I/O15	I/O30	TDI											TDO	I/O150	I/O167	I/O183	E			
F	GND	I/O16	I/O31	I/O47											I/O137	I/O151	I/O168	GND	F			
G	I/O3	I/O17	I/O32	V <sub>CC</sub>											V <sub>CC</sub>	I/O152	I/O169	I/O184	G			
H	GND	I/O18	I/O33	I/O48											I/O138	I/O153	I/O170	GND	H			
J	I/O4	I/O19	I/O34	I/O49											I/O139	I/O154	I/O171	I/O185	J			
K	GND	I/O1CK0	I/O35	I/O50											I/O140	I/O155	I <sub>3</sub> /CLK3	I/O186	K			
L	I/O5	I <sub>1</sub> /CLK1	I/O36	I/O51											I/O141	I/O156	I <sub>2</sub> /CLK2	GND	L			
M	I/O6	I/O20	I/O37	I/O52											I/O142	I/O157	I/O172	I/O187	M			
N	GND	I/O21	I/O38	I/O53											I/O143	I/O158	I/O173	GND	N			
P	I/O7	I/O22	I/O39	V <sub>CC</sub>											V <sub>CC</sub>	I/O159	I/O174	I/O188	P			
R	GND	I/O23	I/O40	I/O54												I/O144	I/O160	I/O175	GND	R		
T	I/O8	I/O24	I/O41	TCK											TMS	I/O161	I/O176	I/O189	T			
U	I/O9	I/O25	I/O42	V <sub>CC</sub>	V <sub>CC</sub>	I/O67	V <sub>CC</sub>	I/O80	I/O87	I/O93	I/O99	I/O105	I/O112	V <sub>CC</sub>	I/O125	V <sub>CC</sub>	V <sub>CC</sub>	I/O162	I/O177	I/O190	U	
V	I/O10	I/O26	V <sub>CC</sub>	I/O55	I/O61	I/O68	I/O73	I/O81	I/O88	I/O94	I/O100	I/O106	I/O113	I/O119	I/O126	I/O131	I/O145	V <sub>CC</sub>	I/O178	I/O191	V	
W	GND	I/O27	I/O43	I/O56	I/O62	I/O69	I/O74	I/O82	I/O89	I/O95	I/O101	I/O107	I/O114	I/O120	I/O127	I/O132	I/O146	I/O163	I/O179	GND	W	
Y	GND	GND	GND	I/O57	I/O63	GND	I/O75	I/O83	GND	GND	GND	GND	GND	I/O115	I/O121	GND	I/O133	I/O147	GND	I/O180	GND	Y

### Pin Designations

- CLK = Clock
- GND = Ground
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- I/O = Input/Output
- NC = No Connect
- V<sub>CC</sub> = Supply Voltage
- TDI = Test Data In
- TCK = Test Clock
- TMS = Test Mode Select
- TDO = Test Data Out

**Select devices have been discontinued.**  
**See Ordering Information section for product status.**

## 352-BALL BGA CONNECTION DIAGRAM — M5-512, M5LV-512

Bottom View (I/O Pin-outs)

352-Ball BGA

A	NC	GND	NC	I/O51	GND	I/O73	I/O80	I/O87	GND	I/O101	NC	I/O114	GND	I/O128	I/O134	I/O142	GND	I/O156	I/O162	GND	NC	GND	NC	NC	A			
B	NC	GND	NC	I/O52	I/O68	I/O74	I/O81	I/O88	I/O95	I/O102	I/O107	I/O115	I/O122	I/O129	I/O135	I/O143	I/O150	I/O157	I/O163	I/O169	I/O176	I/O183	I/O188	GND	NC	NC	B	
C	GND	I/O11	TDI	I/O53	I/O69	I/O75	I/O82	I/O89	I/O96	I/O103	I/O108	I/O116	I/O123	I/O130	I/O136	I/O144	I/O151	I/O158	I/O160	I/O169	I/O170	I/O177	I/O184	NC	NC	NC	C	
D	I/O0	I/O12	I/O32	V <sub>CC</sub>	I/O70	I/O76	I/O83	I/O90	V <sub>CC</sub>	I/O104	I/O109	I/O117	V <sub>CC</sub>	I/O131	I/O137	I/O145	V <sub>CC</sub>	I/O159	I/O165	I/O171	I/O178	V <sub>CC</sub>	TDO	I/O205	I/O224	GND	D	
E	NC	I/O13	I/O33	I/O54																	I/O189	I/O206	I/O225	NC	NC	E		
F	GND	I/O14	I/O34	I/O55																	I/O190	I/O207	I/O226	I/O245		F		
G	I/O1	I/O15	I/O35	V <sub>CC</sub>																	I/O191	I/O208	I/O227	GND	G			
H	I/O2	I/O16	I/O36	I/O56																	V <sub>CC</sub>	I/O209	I/O228	I/O246	H			
J	GND	I/O17	I/O37	V <sub>CC</sub>																	I/O192	I/O210	I/O229	I/O247	J			
K	I/O3	I/O18	I/O38	I/O57																	V <sub>CC</sub>	I/O211	I/O230	GND	K			
L	I/O4	I/O19	I/O39	I/O58																	I/O193	I/O212	I/O231	I/O248	L			
M	I/O5	I/O20	I/O40	I/O59																	I/O194	I/O213	I/O232	I/O249	M			
N	GND	I/O21	I/OCLK0	V <sub>CC</sub>																	I/O195	I/O214	I/O233	I/OCLK3	N			
P	I/OCLK1	I/O22	I/O41	I/O60																	V <sub>CC</sub>	I/O215	I/O234	GND	P			
R	I/O6	I/O23	I/O42	I/O61																	I/O196	I/O216	I/O235	I/O250	R			
T	I/O7	I/O24	I/O43	I/O62																	I/O197	I/O216	I/O236	I/O251	T			
U	GND	I/O25	I/O44	V <sub>CC</sub>																	I/O198	I/O217	I/O237	I/O252	U			
V	I/O8	I/O26	I/O45	I/O63																	V <sub>CC</sub>	I/O218	I/O238	GND	V			
W	I/O9	I/O27	I/O46	V <sub>CC</sub>																	I/O199	I/O219	I/O239	I/O253	W			
Y	GND	I/O28	I/O47	I/O64																	V <sub>CC</sub>	I/O220	I/O240	I/O254	Y			
AA	I/O10	I/O29	I/O48	I/O65																	I/O200	I/O221	I/O241	GND	AA			
AB	NC	I/O30	I/O49	I/O66																	I/O201	I/O222	I/O242	NC	AB			
AC	GND	I/O31	I/O50	TCK	V <sub>CC</sub>	I/O77	I/O84	I/O91	I/O97	V <sub>CC</sub>	I/O110	I/O118	I/O124	V <sub>CC</sub>	I/O138	I/O146	I/O152	V <sub>CC</sub>	I/O168	I/O172	I/O179	I/O185	V <sub>CC</sub>	I/O223	I/O243	I/O255	AC	
AD	NC	NC	NC	NC	I/O71	I/O78	I/O85	I/O92	I/O98	I/O105	I/O111	I/O119	I/O125	I/O132	I/O139	I/O147	I/O153	I/O160	I/O167	I/O173	I/O180	I/O186	I/O202	TMS	I/O244	GND	AD	
AE	NC	NC	GND	I/O67	I/O72	I/O79	I/O86	I/O93	I/O99	I/O106	I/O112	I/O120	I/O126	I/O133	I/O140	I/O154	I/O161	I/O168	I/O174	I/O181	I/O187	I/O191	I/O203	NC	GND	NC	AE	
AF	NC	NC	GND	NC	GND	NC	GND	I/O94	I/O100	GND	I/O113	I/O121	I/O127	GND	I/O141	I/O149	I/O155	GND	I/O175	I/O182	GND	I/O204	NC	GND	NC	AF		
26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1			

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20446G-030

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